

Bipolar Transistors Silicon NPN Epitaxial Type

# 2SC4738

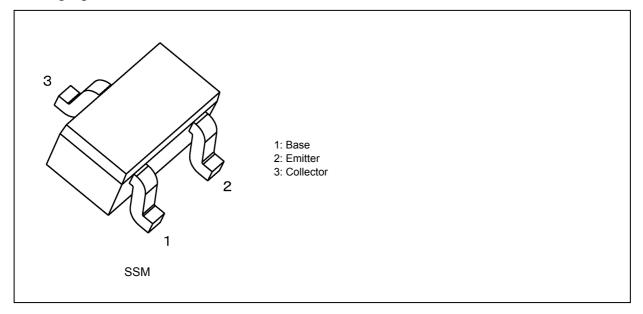
## 1. Applications

- Low-Frequency Amplifiers
- AM Amplifiers

#### 2. Features

- (1) AEC-Q101 qualified (Please see the orderable part number list)
- (2) High voltage:  $V_{CEO} = 50 \text{ V}$
- (3) High collector current:  $I_C = 150 \text{ mA (max)}$
- (4) High  $h_{FE}$ :  $h_{FE} = 120$  to 700
- (5) Excellent h<sub>FE</sub> linearity:  $h_{FE}$  ( $I_C = 0.1$  mA)/ $h_{FE}$  ( $I_C = 2$  mA) = 0.95 (typ.)
- (6) Complementary to 2SA1832
- (7) Small package

### 3. Packaging



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#### 4. Orderable part number

Orderable part number		AEC-Q10	AEC-Q101		Note		
2SC4738-Y	2SC4738-Y,LF	_		General Use			
	2SC4738-Y,LXGF	YES	(Note 1)	Unintended Use	(Note 1)		
	2SC4738-Y,LXHF	YES		Automotive Use			
2SC4738-GR	2SC4738-GR,LF	_		General Use			
	2SC4738-GR,LXGF	YES	(Note 1)	Unintended Use	(Note 1)		
	2SC4738-GR,LXHF	YES		Automotive Use			
2SC4738-BL	2SC4738-BL,LF	_		General Use			
	2SC4738-BL,LXGF	YES	(Note 1)	Unintended Use	(Note 1)		
	2SC4738-BL,LXHF	YES		Automotive Use			

Note 1: For more information, please contact our sales or use the inquiry form on our website.

### 5. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics			Rating	Unit
Collector-base voltage		$V_{CBO}$	60	V
Collector-emitter voltage			50	V
Emitter-base voltage		$V_{EBO}$	5	٧
Collector current (DC)			150	mA
Base current		$I_{B}$	30	mA
Collector power dissipation	(Note 2), (Note 4)	P <sub>C</sub>	120	mW
	(Note 3)		100	
Junction temperature	(Note 2)	Tj	150	ů
	(Note 3)		125	
Storage temperature	(Note 2)	T <sub>stg</sub>	-55 to 150	Ŝ
	(Note 3)		-55 to 125	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 2: For devices with the ordering part number ending in LF(T.
- Note 3: For devices with the ordering part number ending in XGF(T, XHF(T.
- Note 4: Device mounted on an 25.4 mm  $\times$  25.4 mm  $\times$  1.6 mm FR4 glass epoxy board (Cu pad: 0.36 mm $^2 \times$  3)

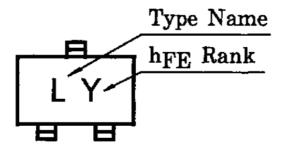


# 6. Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>		$V_{CB} = 60 \text{ V}, I_{E} = 0 \text{ mA}$	_	_	0.1	μА
Emitter cut-off current	I <sub>EBO</sub>		$V_{EB}$ = 5 V, $I_C$ = 0 mA			0.1	μА
DC current gain	h <sub>FE</sub>	(Note 5)	$V_{CE}$ = 6 V, $I_C$ = 2 mA	120	_	700	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>		I <sub>C</sub> = 100 mA, I <sub>B</sub> = 10 mA		0.1	0.25	V
Transition frequency	f <sub>T</sub>		V <sub>CE</sub> = 10 V, I <sub>C</sub> = 1 mA	80	_	_	MHz
Collector output capacitance	C <sub>ob</sub>		V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0 A, f = 1 MHz	_	2.0	3.5	pF

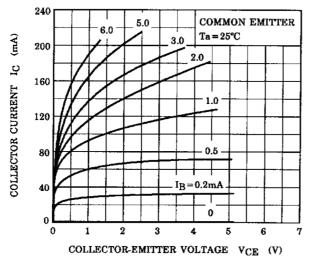
Note 5:  $h_{FE}$  classification Y (Y): 120 to 240, GR (G): 200 to 400, BL (L): 350 to 700 ( ) marking symbol

## 7. Marking





## 8. Characteristics Curves (Note)



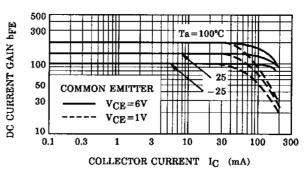
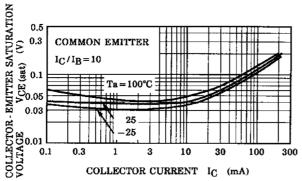


Fig. 8.1 Ic - VcE

Fig. 8.2 hFE - IC



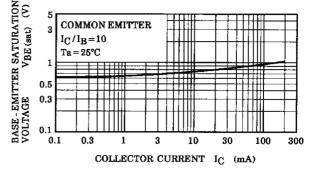


Fig. 8.3 V<sub>CE(sat)</sub> - I<sub>C</sub>

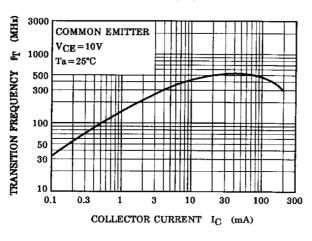


Fig. 8.4 V<sub>BE(sat)</sub> - I<sub>C</sub>

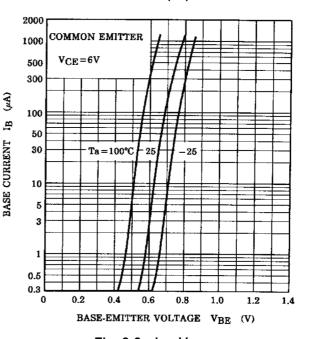


Fig. 8.5 f<sub>T</sub> - I<sub>C</sub>

Fig. 8.6 IB - VBE



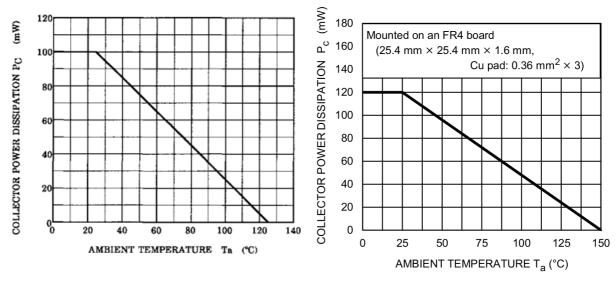


Fig. 8.7  $\;$  PC -  $T_a$  Reference only with  $T_j$  of 125  $^{\circ} C.$ 

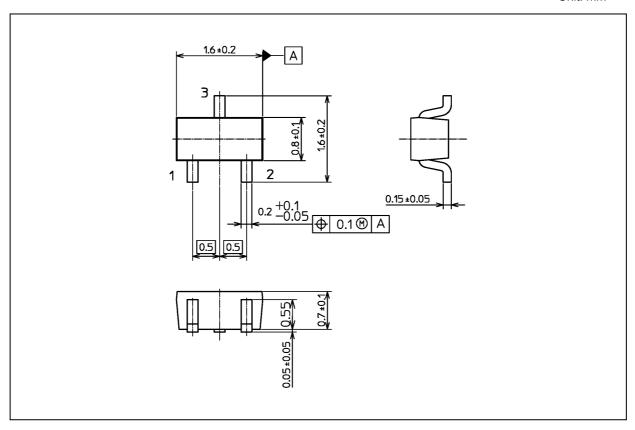
Fig. 8.8  $P_C$  -  $T_a$  Reference only with  $T_j$  of 150  $^{\circ}$ C.

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



# **Package Dimensions**

Unit: mm



Weight: 2.4 mg (typ.)

Package Name(s)		
TOSHIBA: 2-2H1S		
Nickname: SSM		

Rev.3.0



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